FLS3217 / FLS3247 — Single-Stage PFC Primary-Side-Regulation Offline LED Driver with Integrated Power MOSFET

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## FLS3217 / FLS3247 Single-Stage PFC Primary-Side-Regulation Offline LED Driver with Integrated Power MOSFET

#### Features

- Cost-Effective Solution without Input Bulk Capacitor and Feedback Circuitry
- Power-Factor Correction (PFC)
- Integrated Power MOSFET
- Accurate Constant-Current (CC) Control Independent Online Voltage, Output Voltage, and Magnetizing Inductance Variation
- Linear Frequency Control for Increased Efficiency
- Open / Short-LED Protection
- Cycle-by-Cycle Current Limiting
- Over-Temperature Protection with Auto Restart
- Low Startup Current: 20µA
- Low Operating Current: 5mA
- V<sub>DD</sub> Over-Voltage Protection (OVP)
- V<sub>DD</sub> Under-Voltage Lockout (UVLO)
- Application Voltage Range: 80 V<sub>AC</sub> ~ 308 V<sub>AC</sub>

#### Applications

LED Lighting System

#### Description

This highly integrated PWM controller with power MOSFET, FLS3217 / FLS3247, provides several features to enhance the performance of low-power flyback converters. The proprietary topology enables simplified circuit design for LED lighting applications.

By using the single-stage topology with primary-side regulation, an LED lighting board can be implemented with the few external components and minimized cost; requiring no input bulk capacitor or feedback circuitry. To implement good power factor and low THD, constant on-time control is utilized with an external capacitor connected to COMI.

Precise constant-current control regulates accurate output current versus changes in input voltage and output voltage. The operating frequency is proportionally changed by the output voltage to guarantee DCM operation with higher efficiency and simple design.

FLS3217 and FLS3247 provide protection features such as open-LED, short-LED, and over-temperature protection. The current-limit level is automatically reduced to minimize the output current and protect external components in short-LED condition.

Ordering Information				
Part Number	Operating Temperature Range	Package	Packing Method	
FLS3217M		7-Lead, Small Outline Package (SOIC)	Tape & Reel	
FLS3217N	-40°C to +125°C	7 Lood Small Outling Rockage (DIR)	Tubo	
FLS3247N			TUDE	





DRAIN

7

Power MOSFET Drain. This pin is the high-voltage power MOSFET drain.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit	
V <sub>VDD</sub>	DC Supply Voltage <sup>(1,2)</sup>			30	V	
V <sub>VS</sub>	VS Pin Input Voltage		-0.3	7.0	V	
V <sub>CS</sub>	CS Pin Input Voltage		-0.3	7.0	V	
V <sub>COMI</sub>	COMI Pin Input Voltage		-0.3	7.0	V	
I <sub>D</sub>	Continuous Drain Current	T <sub>A</sub> =25°C, FLS3217M/N		1	A	
		T <sub>A</sub> =25°C, FLS3247N		4		
	Rulaad Drain Current	FLS3217M/N		4	^	
IDM	Puised Drain Current	FLS3247N		16	A	
1	Avalancho Curront	FLS3217M/N	-	1	۸	
IAR		FLS3247N		4	A	
	Device Dissignation	SOIC, T <sub>A</sub> <50°C		660	mW	
PD	Power Dissipation	DIP, T <sub>A</sub> <50°C		1	W	
		SOIC, T <sub>A</sub> <50°C		150	°C/W	
$\Theta_{JA}$	I nermal Resistance (Junction-to-Air)	DIP, T <sub>A</sub> <50°C		95		
		SOIC, T <sub>A</sub> <50°C		40	°C/W	
$\Theta_{JC}$	I hermal Resistance (Junction-to-Case)	DIP, T <sub>A</sub> <50°C		25		
TJ	Maximum Junction Temperature			+150	°C	
T <sub>STG</sub>	Storage Temperature Range		-55	+150	°C	
TL	Lead Temperature (Soldering 10 second		+260	°C		
FOD	ESD Capability, Human Body Model			5	M	
ESD	ESD Capability, Charged Device Model			2	V	

Notes:

1. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.

2. All voltage values, except differential voltages, are given with respect to GND pin.

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
T <sub>A</sub>	Operating Ambient Temperature	-40	125	°C

## **Electrical Characteristics**

Unless otherwise specified,  $V_{DD}$ =15 V and T<sub>A</sub>=25°C.

Symbol	Paramet	ter	Condition	Min.	Тур.	Max.	Unit
MOSFET Sec	ction						1
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage		I <sub>D</sub> =250 μΑ, V <sub>GS</sub> =0 V	700			V
R <sub>DS(ON)</sub>		FLS3217M		13	16	Ω	
	Static Drain-Source	FLS3217N	- I <sub>D</sub> =0.5 A, V <sub>GS</sub> =10 V		8.8	11.0	Ω
	On resistance	FLS3247N	I <sub>D</sub> =1 A, V <sub>GS</sub> =10 V		2.4	2.8	Ω
		FLS3217M	V <sub>GS</sub> =0 V, V <sub>DS</sub> =25 V, f <sub>2</sub> =1 MHz		175	200	pF
CISS	Input Capacitance	FLS3217N			250		pF
		FLS3247N			435		pF
		FLS3217M			23	25	pF
Coss	Output Capacitance	FLS3217N	∇ <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f <sub>c</sub> =1MHz		25		pF
		FLS3247N	15-11112		51		pF
V <sub>DD</sub> Section							
V <sub>DD-ON</sub>	Turn-On Threshold V	/oltage		14.5	16.0	17.5	V
V <sub>DD-OFF</sub>	Turn-Off Threshold V	/oltage		6.75	7.75	8.75	V
I <sub>DD-OP</sub>	Operating Current		V <sub>S</sub> =2.4 V, C <sub>L</sub> =MOSFET C <sub>ISS</sub>	2.85	4.00	5.00	mA
I <sub>DD-ST</sub>	Startup Current	Startup Current			2	20	μA
V <sub>OVP</sub>	V <sub>DD</sub> Over-Voltage Protection Level			22.0	23.5	25.0	V
Oscillator Se	ection						
f <sub>MAX-CC</sub>	Maximum Frequency in CC		V <sub>DD</sub> =10 V, 20 V	60	65	70	kHz
f <sub>MIN-CC</sub>	Minimum Frequency in CC		V <sub>DD</sub> =10 V, 20 V	21.0	23.5	26.0	kHz
VS <sub>MAX-CC</sub>	VS for Maximum Frequency in CC		Frequency=Maximum Frequency-2 kHz	2.25	2.35	2.45	V
VS <sub>MIN-CC</sub>	VS for Minimum Frequency in CC		Frequency=Minimum Frequency +1 kHz	0.55	0.85	1.15	V
t <sub>ON(MAX)</sub>	Maximum Turn-on Ti	ime		12	14	16	μs
Current-Sens	se Section		·				
V <sub>RV</sub>	Reference Voltage			2.475	2.500	2.525	V
V <sub>CCR</sub>	Variation Test Voltage on CS Pin for Constant Current Regulation		V <sub>CS</sub> =0.24 V	2.38	2.43	2.48	V
t <sub>LEB</sub>	Leading-Edge Blanking Time				300		ns
t <sub>MIN</sub>	Minimum On Time in CC		V <sub>VS</sub> =-0.5 V, V <sub>CS</sub> =1.5 V		600		ns
t <sub>PD</sub>	Propagation Delay to GATE Output			50	100	150	ns
D <sub>SAW</sub>	Duty Cycle of SAW Limiter				40		%
t <sub>DIS-BNK</sub>	t <sub>DIS</sub> Blanking Time of	VS			1.5		μs
I <sub>VS-BNK</sub>	VS Current for VS BI	anking			100		μA

Continued on the following page...

## Electrical Characteristics (Continued)

Unless otherwise specified,  $V_{DD}$ =15 V and  $T_A$ =25°C.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
Current-Erro	Current-Error-Amplifier Section						
Gm	Transconductance			85		μmho	
I <sub>COMI-SINK</sub>	COMI Sink Current	V <sub>EAI</sub> =3 V, V <sub>COMI</sub> =5 V	25		38	μA	
I <sub>COMI-SOURCE</sub>	COMI Source Current	V <sub>EAI</sub> =2 V, V <sub>COMI</sub> =0 V	25		38	μΑ	
V <sub>COMI-HGH</sub>	COMI High Voltage	V <sub>EAI</sub> =2 V	4.7			V	
V <sub>COMI-LOW</sub>	COMI Low Voltage	V <sub>EAI</sub> =3 V			0.1	V	
Over-Currer	Over-Current Protection Section						
V <sub>OCP</sub>	V <sub>CS</sub> Threshold Voltage for OCP	0.60	0.67	0.74	V		
VLowOCP	V <sub>cs</sub> Threshold Voltage for Low OCP		0.13	0.18	0.23	V	
V <sub>LowOCP-EN</sub>	VS Threshold Voltage to Enable LOW OCP Level			0.40		V	
V <sub>LowOCP-DIS</sub>	VS Threshold Voltage to Disable LOW OCP Level			0.60		V	
Over-Temperature-Protection Section							
T <sub>OTP</sub>	Threshold Temperature for OTP <sup>(3)</sup>		140	150	160	°C	
T <sub>OTP-HYS</sub>	Restart Junction Temperature Hysteresis			10		°C	

Note:

3. When the over-temperature protection (OTP) is activated, the power system enters Auto-Recovery Mode and output is disabled.





## **Functional Description**

FLS3217 / FLS3247 is an AC-DC PWM controller for LED lighting applications. TRUECURRENT<sup>®</sup> techniques regulate accurate LED current independent of input voltage, output voltage, and magnetizing inductance variations. The linear frequency control in the oscillator reduces conduction loss and maintains DCM operation in the wide range of output voltage, which implements high power factor correction in a single-stage flyback topology. A variety of protections, such as short/open-LED protection, over-temperature protection, and cycleby-cycle current limitation stabilize system operation and protect external components.

#### Startup

Powering at startup is slow due to the low feedback-loop bandwidth in the PFC converter. To increase power during startup, the internal oscillator counts 12ms to define Startup Mode. During Startup Mode, turn-on time is determined by current-mode control with 0.2V voltage limit. Transconductance becomes 14 times bigger, as shown in Figure 15. After Startup Mode, turn-on time is controlled by Voltage Mode, using the COMI voltage. The error amplifier transconductance is reduced to 85µmho.



#### **Constant Current Regulation**

The output current can be estimated using the peak drain current and inductor current discharge time because output current is same as the average of the diode current in steady state. The peak value of the drain current is determined by the CS pin and the inductor discharge time ( $t_{DIS}$ ) is sensed by  $t_{DIS}$  detector. By using three pieces of information (peak drain current, inductor discharging time, and operating switching period); the TRUECURRENT block calculates estimates the output current. The output of the TRUECURRENT calculation is compared with an internal precise reference to generate an error voltage,  $V_{COMI}$ , which determines the turn-on time in Voltage-Mode control. With Fairchild's innovative technique, constant current output can be precisely controlled.

# Power-Factor Controller (PFC) and Total Harmonic Distortion (THD)

In a conventional boost converter, Boundary Conduction Mode (BCM) is generally used to keep input current in phase with input voltage for Power Factor (PF) and Total Harmonic Distortion (THD). In flyback / buck boost topology, constant turn-on time and constant frequency I Discontinuous Conduction Mode (DCM) can implement high PF and low THD as shown in Figure 16. Constant turn-on time is maintained by the internal error amplifier and a large external capacitor (typically over 1µF) at the COMI pin. Constant frequency and DCM operation is managed by linear frequency control.





#### Linear Frequency Control

DCM should be guaranteed for high power factor in flyback topology. To maintain DCM in the wide range of output voltage, frequency is linearly changed by output voltage in linear frequency control. Output voltage is detected by auxiliary winding and a resistive divider connected to the VS pin, as shown in Figure 17.



Figure 17. Linear Frequency Control

When the output voltage decreases, the secondary diode conduction time is increased and the linear frequency control lengthens the switching period. This maintains DCM operation in the wide output voltage range, as shown in Figure 18. The frequency control also lowers primary rms current with better power efficiency in full-load condition.



Figure 18. Primary and Secondary Current

#### **BCM Control**

The end of secondary diode conduction time is possibly over a switching period set by linear frequency control. In this case, FLS3217 and FLS3247 don't allow CCM and the operation mode changes from DCM to BCM. Therefore, FLS3217 and FLS3247 eliminate subharmonic distortion in CCM.

#### **Short-LED Protection**

In the event of a short LED condition, the switching MOSFET and secondary diode are usually stressed by the high-power current. However, FLS3217 and FLS3247 change OCP level in short-LED condition. When  $V_{\rm S}$  is lower than 0.4 V, the OCP level lowers to 0.2 V from 0.7 V, as shown in Figure 17. Power is limited and external component current stress is relieved.



Figure 19. Internal OCP Block

Figure 20 shows operational waveforms at short-LED condition. Output voltage is quickly lowered to 0V after the LED-short event. Then the reflected auxiliary voltage is also 0V, making V<sub>S</sub> less than 0.4 V. 0.2 V OCP level limits the primary-side current and V<sub>DD</sub> "hiccups" up and down in between UVLO hysteresis.





#### **Open LED Protection**

FLS3217 and FLS3247 protect external components, such as diode and capacitor, at secondary side in open-LED condition. During switch-off, the  $V_{DD}$  capacitor is charged up to the auxiliary winding voltage, which is applied as the reflected output voltage. Because the  $V_{DD}$  voltage has output voltage information, the internal voltage comparator on the VDD pin can trigger output over-voltage protection (OVP), as shown in Figure 21. When at least one LED is open-circuited, output load impedance becomes very high and the output capacitor is quickly charged up to  $V_{OVP} \times Ns / Na$ . Then switching is shutdown and  $V_{DD}$  block goes into "Hiccup Mode" until the open-LED condition is removed, shown in Figure 22.





Figure 22. Waveforms at Open-LED Condition

#### Under-Voltage Lockout (UVLO)

The turn-on and turn-off thresholds are fixed internally at 16 V and 7.5 V, respectively. During startup, the VDD capacitor must be charged to 16 V through the startup resistor, so that the FLS32x7 is enabled. The VDD capacitor supplies VDD until power can be delivered from the auxiliary winding of the main transformer. VDD must not drop below 7.5 V during startup. The UVLO hysteresis window ensures that the VDD capacitor is adequate to supply VDD during startup.

#### **Over-Temperature Protection (OTP)**

The built-in temperature-sensing circuit shuts down PWM output once the junction temperature exceeds 150°C. While PWM output is off, VDD gradually drops to the UVLO voltage. Some of the internal circuits are shut down and VDD gradually increases again. When VDD reaches 16 V, all the internal circuits start operating. If the junction temperature is still higher than 140°C, the PWM controller shuts down immediately.







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LAND PATTERN RECOMMENDATION







**OPTION B - NO BEVEL EDGE** 



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